5V ECL 3-Bit Scannable Registered Bus Transceiver

The MC10E/100E337 is a 3-bit registered bus transceiver with scan. The bus outputs (BUS0–BUS2) are specified for driving a 25 Ω bus; the receive outputs (Q0–Q2) are specified for 50 Ω The bus outputs feature a normal HIGH level (V $_{OH}$) and a cutoff LOW level — when LOW, the outputs go to –2.0 V and the output emitter-follower is "off", presenting a high impedance to the bus. The bus outputs also feature edge slow-down capacitors.

Both drive and receive sides feature the same logic, including a loopback path to hold data. The HOLD/LOAD function is controlled by Transmit Enable (TEN) and Receive Enable (REN) on the transmit and receive sides respectively, with a HIGH selecting LOAD. Note that the implementation of the E337 Receive Enable differs from that of the E336.

A synchronous bus enable (SBUSEN) is provided for normal, non-scan operation. The asynchronous bus disable $(\overline{ABUSDIS})$ disables the bus immediately for scan mode.

The SYNCEN input is provided for flexibility when re-enabling the bus after disabling with ABUSDIS, allowing either synchronous or asynchronous re-enabling. An alternative use is asynchronous-only operation with ABUSDIS, in which case SYNCEN is tied LOW, or left open. SYNCEN is implemented as an overriding SET control (active-LOW) to the enable flip-flop.

Scan mode is selected by a HIGH at the SCAN input. Scan input data is shifted in through S_IN and output data appears at the Q2 output.

All registers are clocked on the positive transition of CLK. Additional lead-frame grounding is provided through the Ground pins (GND) which should be connected to 0V. The GND pins are not electrically connected to the chip.

The 100 Series contains temperature compensation.

- Scannable Version of E336
- 25 Ω Cutoff Bus Outputs
- 50 Ω Receiver Outputs
- Scannable Registers
- Sync. and Async. Bus Enables
- Non-inverting Data Path
- 1500 ps Max. Clock to Bus (Data Transmit)
- 1000 ps Max. Clock to Q (Data Receive)
- Bus Outputs Feature Internal Edge Slow-Down Capacitors
- Additional Package Ground Pins
- PECL Mode Operating Range: V_{CC}= 4.2 V to 5.7 V with V_{EE}= 0 V
- NECL Mode Operating Range: V_{CC} = 0 V with V_{EE} = -4.2 V to -5.7 V
- Internal Input Pulldown Resistors
- ESD Protection: > 1 KV HBM, > 75 V MM
- Meets or Exceeds JEDEC Spec EIA/JESD78 IC Latchup Test

For Additional Information, see Application Note AND8003/D

- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
- Transistor Count = 471 devices



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CASE 776

A = Assembly Location WL = Wafer Lot

YY = Year WW = Work Week



MARKING



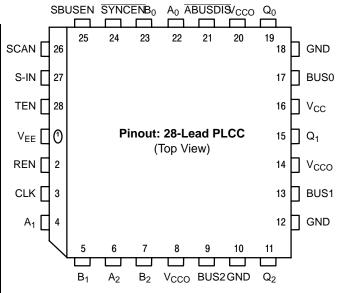
ORDERING INFORMATION

Device	Package	Shipping
MC10E337FN	PLCC-28	37 Units/Rail
MC10E337FNR2	PLCC-28	500 Units/Reel
MC100E337FN	PLCC-28	37 Units/Rail
MC100E337FNR2	PLCC-28	500 Units/Reel

PIN DESCRIPTION

PIN	FUNCTION
A ₀ – A ₂	ECL Data Inputs A
$B_0 - B_2$	ECL Data Inputs B
S-IN	ECL Serial (Scan) Data Input
TEN, REN	HOLD/LOAD Controls
SCAN	ECL Scan Control
ABUSDIS	ECL Asynchronous Bus Disable
SBUSEN	ECL Synchronous Bus Enable
SYNCEN	ECL Synchronous Enable Control
CLK	ECL Clock
BUS0 - BUS2	ECL 25Ω Cutoff Bus Outputs
$Q_0 - Q_2$	ECL Receive Data Outputs (Q2 serves as SCAN_OUT in scan mode)
V _{CC} , V _{CCO}	Positive Supply
V _{EE}	Negative Supply
GND	Ground

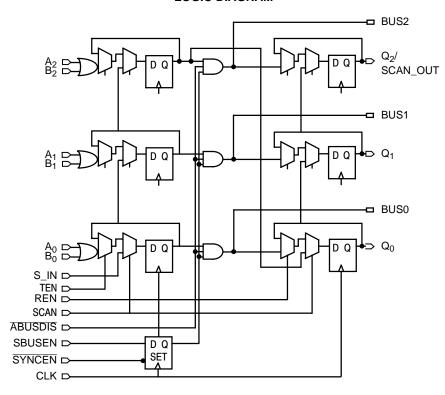
LOGIC DIAGRAM AND PINOUT ASSIGNMENT



 $^{^{\}star}$ All V_{CC} and V_{CCO} pins are tied together on the die.

Warning: All V_{CC} , V_{CCO} , and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

LOGIC DIAGRAM



MAXIMUM RATINGS (Note 1.)

Symbol	Parameter	Condition 1	Condition 2	Rating	Units
V _{CC}	PECL Mode Power Supply	V _{EE} = 0 V		8	V
V _{EE}	NECL Mode Power Supply	V _{CC} = 0 V		-8	V
VI	PECL Mode Input Voltage NECL Mode Input Voltage	V _{EE} = 0 V V _{CC} = 0 V	$\begin{aligned} & V_{I} \leq V_{CC} \\ & V_{I} \geq V_{EE} \end{aligned}$	6 -6	V V
I _{out}	Output Current	Continuous Surge		50 100	mA mA
TA	Operating Temperature Range			0 to +85	°C
T _{stg}	Storage Temperature Range			-65 to +150	°C
θ_{JA}	Thermal Resistance (Junction to Ambient)	0 LFPM 500 LFPM	28 PLCC 28 PLCC	63.5 43.5	°C/W
θ_{JC}	Thermal Resistance (Junction to Case)	std bd	28 PLCC	22 to 26	°C/W
V _{EE}	PECL Operating Range NECL Operating Range			4.2 to 5.7 -5.7 to -4.2	V V
T _{sol}	Wave Solder	<2 to 3 sec @ 248°C		265	°C

^{1.} Maximum Ratings are those values beyond which device damage may occur.

10E SERIES PECL DC CHARACTERISTICS V_{CCx}= 5.0 V; V_{EE}= 0.0 V (Note 1.)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		145	174		145	174		145	174	mA
V _{OH}	Output HIGH Voltage (Note 2.)	3980	4070	4160	4020	4105	4190	4090	4185	4280	mV
V _{OL}	Output LOW Voltage (Note 2.)	3050	3210	3370	3050	3210	3370	3050	3227	3405	mV
V _{IH}	Input HIGH Voltage	3830	3995	4160	3870	4030	4190	3940	4110	4280	mV
V _{IL}	Input LOW Voltage	3050	3285	3520	3050	3285	3520	3050	3302	3555	mV
V _{CUT}	Cut-off Output Voltage (Note 2.)	2.9		2.97	2.9		2.97	2.9		2.97	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5	0.3		0.5	0.25		0.3	0.2		μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

10E SERIES NECL DC CHARACTERISTICS V_{CCx} = 0.0 V; V_{EE} = -5.0 V (Note 1.)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		145	174		145	174		145	174	mA
V _{OH}	Output HIGH Voltage (Note 2.)	-1020	-930	-840	-980	-895	-810	-910	-815	-720	mV
V _{OL}	Output LOW Voltage (Note 2.)	-1950	-1790	-1630	-1950	-1790	-1630	-1950	-1773	-1595	mV
V _{IH}	Input HIGH Voltage	-1170	-1005	-840	-1130	-970	-810	-1060	-890	-720	mV
V _{IL}	Input LOW Voltage	-1950	-1715	-1480	-1950	-1715	-1480	-1950	-1698	-1445	mV
V _{CUT}	Cut-off Output Voltage (Note 2.)	2.9		2.97	2.9		2.97	2.9		2.97	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5	0.3		0.5	0.065		0.3	0.2		μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

^{1.} Input and output parameters vary 1:1 with V_{CC} . V_{EE} can vary +0.46 V / -0.06 V.

^{2.} Outputs are terminated through a 50 ohm resistor to V_{CC} –2.10 volts.

^{1.} Input and output parameters vary 1:1 with V_{CC}. $\rm \dot{V}_{EE}$ can vary +0.46 V / –0.06 V.

^{2.} Outputs are terminated through a 50 ohm resistor to $V_{\mbox{CC}}$ –2.10 volts.

100E SERIES PECL DC CHARACTERISTICS V_{CCx}= 5.0 V; V_{EE}= 0.0 V (Note 1.)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		145	174		145	174		167	200	mA
V _{OH}	Output HIGH Voltage (Note 2.)	3975	4050	4120	3975	4050	4120	3975	4050	4120	mV
V _{OL}	Output LOW Voltage (Note 2.)	3190	3295	3380	3190	3255	3380	3190	3260	3380	mV
V _{IH}	Input HIGH Voltage	3835	4050	4120	3835	4120	4120	3835	4120	4120	mV
V _{IL}	Input LOW Voltage	3190	3300	3525	3190	3525	3525	3190	3525	3525	mV
V _{CUT}	Cut-off Output Voltage (Note 2.)	2.9		2.97	2.9		2.97	2.9		2.97	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.46 V / -0.8 V.

2. Outputs are terminated through a 50 ohm resistor to V_{CC} -2.10 volts.

100E SERIES NECL DC CHARACTERISTICS V_{CCx} = 0.0 V; V_{EE} = -5.0 V (Note 1.)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		145	174		145	174		167	200	mA
V _{OH}	Output HIGH Voltage (Note 2.)	-1025	-950	-880	-1025	-950	-880	-1025	-950	-880	mV
V _{OL}	Output LOW Voltage (Note 2.)	-1810	-1705	-1620	-1810	-1745	-1620	-1810	-1740	-1620	mV
V _{IH}	Input HIGH Voltage	-1165	-950	-880	-1165	-880	-880	-1165	-880	-880	mV
V_{IL}	Input LOW Voltage	-1810	-1700	-1475	-1810	-1475	-1475	-1810	-1475	-1475	mV
V _{CUT}	Cut-off Output Voltage (Note 2.)	2.9		2.97	2.9		2.97	2.9		2.97	V
I _{IH}	Input HIGH Current			150			150			150	μΑ
I _{IL}	Input LOW Current	0.5	0.3		0.5	0.25		0.5	0.2		μΑ

NOTE: Devices are designed to meet the DC specifications shown in the above table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained.

1. Input and output parameters vary 1:1 with V_{CC}. V_{EE} can vary +0.46 V / -0.8 V.

2. Outputs are terminated through a 50 ohm resistor to V_{CC} -2.10 volts.

AC CHARACTERISTICS V_{CCx} = 5.0 V; V_{EE} = 0.0 V or V_{CCx} = 0.0 V; V_{EE} = -5.0 V (Note 1.)

			0°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{MAX}	Maximum Toggle Frequency		TBD			TBD			TBD		GHz
t _{PLH}	Propagation Delay to Output										ps
t _{PHL}	Clk to Q	450		1000	450		1000	450		1000	
	Clk to BUS	800		1800	800		1800	800		1800	
	ABUSDIS	500		1500	500		1500	500		1500	
	SYNCEN	800		1800	800		1800	800		1800	
t _s	Setup Time										ps
	BUS	350			350			350			
	SBUSEN	100			100			100			
	Data, S-IN	400			400			400			
	TEN, REN, SCAN	550			550			550			
t _h	Hold Time										ps
••	BUS	350			350			350			
	SBUSEN	500			500			500			
	Data, S-IN	350			350			350			
	TEN, REN, SCAN	200			200			200			
t _{PW}	Minimum Pulse Width										ps
	CLk	400			400			400			
t _{JITTER}	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
t _r	Rise/Fall Times										ps
t _f	20 - 80% (Qn)	300		800	300		800	300		800	ĺ
	20 - 80% (BUSn Rise)	500		1000	500		1000	500		1000	l
İ	20 - 80% (BUSn Fall)	300		800	300		800	300		800	ĺ

10 Series: V_{EE} can vary +0.46 V / -0.06 V. 100 Series: V_{EE} can vary +0.46 V / -0.8 V.

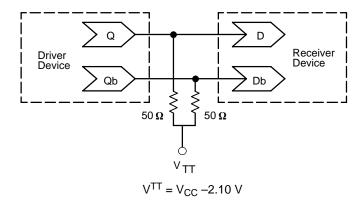


Figure 1. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020 – Termination of ECL Logic Devices.)

Resource Reference of Application Notes

AN1404 – ECLinPS Circuit Performance at Non–Standard V_{IH} Levels

AN1405 – ECL Clock Distribution Techniques

AN1406 – Designing with PECL (ECL at +5.0 V)

AN1503 - ECLinPS I/O SPICE Modeling Kit

AN1504 – Metastability and the ECLinPS Family

AN1568 – Interfacing Between LVDS and ECL

AN1596 – ECLinPS Lite Translator ELT Family SPICE I/O Model Kit

AN1650 – Using Wire–OR Ties in ECLinPS Designs

AN1672 – The ECL Translator Guide

AND8001 - Odd Number Counters Design

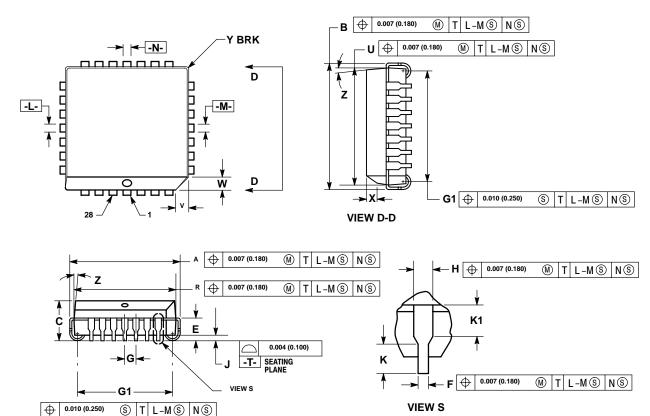
AND8002 - Marking and Date Codes

AND8020 - Termination of ECL Logic Devices

PACKAGE DIMENSIONS

PLCC-28 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 776-02 **ISSUE E**



NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED
 WHERE TOP OF LEAD SHOULDER EXITS
- PLASTIC BODY AT MOLD PARTING LINE.

 2. DIM G1, TRUE POSITION TO BE MEASURED
- AT DATUM -T., SEATING PLANE.

 3. DIM R AND U DO NOT INCLUDE MOLD FLASH.
 ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE
- 4. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST DETERMINED AT THE OUTERMINEST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- PLASTIC BODY.

 DIMENSION H DOES NOT INCLUDE DAMBAR
 PROTRUSION OR INTRUSION. THE DAMBAR
 PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.485	0.495	12.32	12.57
В	0.485	0.495	12.32	12.57
С	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.05	0 BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025	_	0.64	
R	0.450	0.456	11.43	11.58
U	0.450	0.456	11.43	11.58
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Y	_	0.020	_	0.50
Z	2°	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040	_	1.02	



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JAPAN: ON Semiconductor, Japan Customer Focus Center

4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031

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